## Type JAH LSeries

Type JAH LSeries micro fuse is designed for circuit protection against excessive current in portable electronic equipment, electric circuit around battery, etc. because the demand for high capacity batteries is increasing.

Wire material is adopted for fuse element, and the performance against rush current is improved in spite of compact design. Also, the ecology design of TypeJAH LSeries is environmentally friendly because of its complete lead-free.

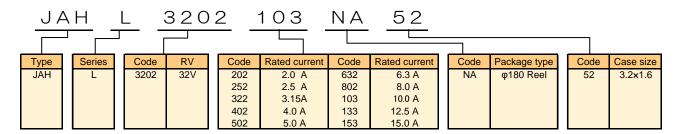
## **FEATURES**

- 1. Our original terminal construction eliminates Tombstone phenomenon.
- 2. Our original construction design provides excellent fusing and quick acting characteristics.
- 3. Especially, performance against rush current is excellent since wire material is used for fuse element.
- 4. Surface temperature rise is 75°C or less when applying rated current for fusing. This gives little influence to the peripheral units.
- 5. Small size of 3216 (  $3.2 \times 1.6 \times 1.2$ mm )
- 6. Suitable for automatic mounting
- 7. Precise dimensions allows high-density mounting and symmetrical construction of terminals provide "Self-Alignment".
- 8. Resistance to soldering heat: Flow soldering 10 seconds at 260°C and Reflow soldering 5 seconds at 250°C respectively.
- 9. A tape carrier of 8 mm width will be provided as a standard package material.
- 10. Complete lead-free

## **RATING**

Item	Rating
Category Temperature Range	-40 ∼+125°C
Rated Current	2.0-2.5-3.15-4.0-5.0-6.3-8.0-10.0-12.5-15.0A
Rated Voltage	32VDC
Voltage Drop	Refer to CATALOG NUMBERS AND RATING
Insulation Resistance (between terminals and case)	1000 MΩ or more
Fusing Characteristics	Fusing within 1 minute if the current is 200% of rated current.
Clearing Characteristics	Breaking voltage : 32 V
	Breaking current : 50 A

## **ORDERING INFORMATION**



## **CATALOG NUMBERS AND RATING**

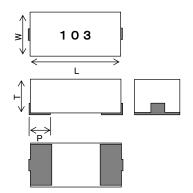
## October, 2014

Catalog number	Case size	Rated current A	Internal resistance mΩ (Typical)	Voltage drop mV (Max.)	Rated voltage VDC	Breaking current A
JAH L 3202 202 □ □52	3.2×1.6	2.0	58	200		
JAH L 3202 252 □ □52	3.2×1.6	2.5	44	200		
JAH L 3202 322 □ □52	3.2×1.6	3.15	34	200		
JAH L 3202 402 □ □52	3.2×1.6	4.0	26	200	32	50
JAH L 3202 502 □ □52	3.2×1.6	5.0	22	200		
JAH L 3202 632 □ □52	3.2×1.6	6.3	16	160	32	50
JAH L 3202 802 □ □52	3.2×1.6	8.0	10	150		
JAH L 3202 103 □ □52	3.2×1.6	10.0	8.2	120		
JAH L 3202 133 □ □52	3.2×1.6	12.5	3.8	80		
JAH L 3202 153 □□52	3.2×1.6	15.0	3.3	65		

For the taping type, the packing code "NA" will be entered in □□. Catalog numbers are approved by UL and cUL. (File No.E170721)



# **DIMENSIONS**



# Main body : Ceramics

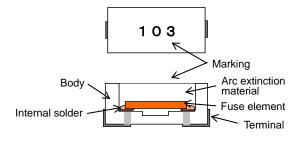
Terminal: Tin plating (mm)						
Case size	Case code	L	W	Т	Р	
3216	52	3.2 <sup>± 0.2</sup>	1.6 <sup>± 0.2</sup>	1.2max.	0.6 <sup>± 0.2</sup>	

# MARKING

: Ra	ated current
:	2.0A
:	2.5A
:	3.15A
:	4.0A
:	5.0A
	: Ra

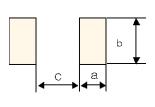
Code	:	Rated current
632	:	6.3A
802	:	8.0A
103	:	10.0A
133	:	12.5A
153	:	15.0A

# **CONSTRUCTION**



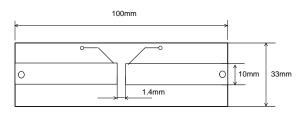
Name	Material, standard, and treatment
Fuse element	Lead-free alloy
Arc extinction material	Silicone resin
Terminal	Tin plating
Body	Ceramics
Marking	Laser printing
Internal solder	Lead-free alloy

## RECOMMENDED PAD DIMENSIONS



	(mm)
	Size 3216
а	1.0
b	1.6
С	1.6
(Reflov	N)

## STANDARD TEST BOARD



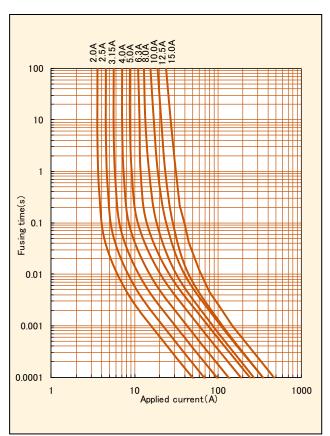
Glass epoxy body on one side Board thickness : 1.6mm Copper layer :  $70\mu m$ 

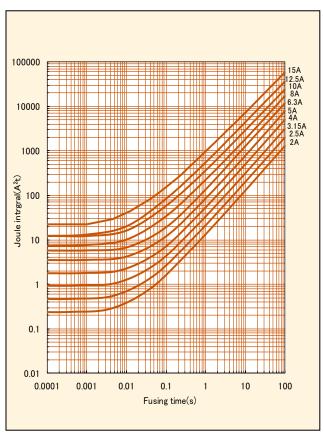
# **PERFORMANCE**

No.	Item	Performance	Test method
1	Temperature rise	Temperature rise shall not exceed 75°C.	Apply rated current.
2	Current-carrying capacity	Shall not open within 1 hour.	Apply 100% of rated current.
3	Clearing characteristics	Arc shall not be continued. Marking shall be legible.	Breaking voltage : Rated voltage Breaking current : 50 A
4	Voltage drop	Voltage drop is below the value specified in CATALOG NUMBERS AND RATING.	Apply rated current.
5	Fusing characteristics	Fusing within 1 min.	Apply 200% of rated current. (Ambient temperature : 10 ~ 30°C)
6	Insulation resistance	1000 MΩ or more	Insulation resistance between terminals and case (ceramics)
7	Electrode strength (Bending)	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Board supporting width: 90 mm Bending speed: Approx. 0.5 mm/sec. Duration: 5 sec. Bending: 3 mm
8	Shear test	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Applied force : 20 N Duration : 10 sec. Tool : R0.5 Direction of the press : side face
9	Substrate bending test	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Supporting dimension : 1.6 mm Applied force : 20 N Duration : 10 sec. Tool : R0.5 Direction of the press : thickness direction of product
10	Solderability (Solder Wetting time)	Solder Wetting time : within 3sec.	Solder: Sn-3Ag-0.5Cu Temperature: 245 ± 3°C meniscograph method Solder: JISZ3282 H60A, H60S, H63A Temperature: 230 ± 2°C meniscograph method
11	Solderability (new uniform coating of solder)	The dipping surface of the terminals shall be covered more than 95% with new solder.	Solder: Sn-3Ag-0.5Cu Temperature: 245 ± 3°C Dipping: 3 sec. Solder: JISZ3282 H60A, H60S, H63A Temperature: 230 ± 2°C Dipping: 3 sec.
12	Resistance to soldering heat	Marking shall be legible. No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Dipping (1 cycle) Preconditioning: $100 \sim 150^{\circ}\text{C}$ , $60 \text{ sec.}$ Temperature: $265 \pm 3^{\circ}\text{C}$ , $6 \sim 7 \text{ sec.}$ $(260 \pm 3^{\circ}\text{C}$ , $10 \text{ sec.})$ Reflow soldering (2 cycles) Preconditioning: $1\text{-}2\text{ m}$ , lower than $180^{\circ}\text{C}$ Peak: $250 \pm 5^{\circ}\text{C}$ , $5 \text{ sec.}$ Holding: $230 \sim 250^{\circ}\text{C}$ , $30 \sim 40 \text{ sec.}$ Cooling: More than 2 min. Manual soldering (2 cycles) Temperature: $350 \pm 10^{\circ}\text{C}$ Duration: $3 \sim 4 \text{ sec.}$ Measure after 1 hour left under room temperature and humidity.
13	Solvent resistance	Marking shall be legible. No mechanical damage. No significant irregularity in the appearance.	Dipping rinse Solvent : Isopropyl alcohol Duration : 90 sec.
14	Vibration	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Frequency range : 10 ~ 55 ~ 10 Hz/m Vibration amplitude : 1.5 mm Duration : 2 hours in each of XYZ directions (total : 6 hours)
15	Shock	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Peak value : 490 m/s <sup>2</sup> Duration : 11 m sec. 6 aspects × 3 times (total : 18 times)
16	Thermal shock	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	-55 ± 3°C: 30 min.  Room temperature: 2 ~ 3 min or less 125 ± 2°C: 30 min.  Room temperature: 2 ~ 3 min or less  Repeat above step for 10 cycles
17	Moisture resistance	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Temperature : 85 ± 3°C Humidity : 85 ± 5% RH Duration : 1000 hours
18	Load life	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Temperature : 85 ± 2°C Applied current : Rated current × 70% Duration : 1000 hours
19	Moisture resistance load	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Temperature : 85 $\pm$ 3°C Humidity : 85 $\pm$ 5% RH Applied voltage : rated current $\times$ 70% Duration : 1000 hours
20	Stability	No mechanical damage. Resistance change after the test shall be within $\pm$ 20%.	Temperature : 125 ± 2°C Duration : 1000 hours

# **FUSING CHARACTERISTICS**

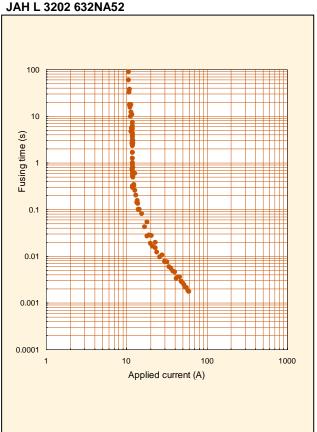
# I<sup>2</sup>T - T CHARACTERISTICS

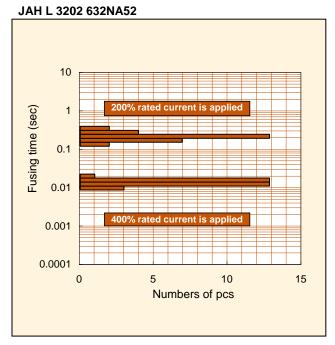




# DISTRIBUTION OF FUSING CHARACTERISTICS

# **DISTRIBUTION OF FUSING TIME**







## DETERMINATION OF RATED VALUE AND SELECTION OF MICRO FUSE (TYPE JAH L Series)

Determine rated value of micro fuse, and select correct circuit protection element for your circuit. If you select correct circuit protection element, safety of your circuit can be ensured.

How to determine rated value of circuit protection element is described below:

#### ■Flow for fuse selection

#### 1. Measurement of circuit values using actual device

Measure circuit values, such as operating current of circuit.

#### Calculation from operating current

From obtained operating current and the category temperature, calculate minimum rated value to determine applicable fuse.

#### 3. Calculation from overload current

From obtained overload current, calculate the maximum rated value to determine applicable fuse.

#### 4. Calculation from inrush current

From inrush current, calculate minimum rated value to determine applicable fuse.

## 5. Final determination of rated value

From the calculation results of steps 2 through 4, determine rated value.

### 6. Operation check using actual device

After selecting rating, confirm if device works properly under pre-determined conditions.

#### ■ Fuse selection

#### 1. Measurement of circuit values using actual device

Before determining rated value of fuse, preliminarily measure following condition by using the actual device.

#### 1-1 Operating current

Using an oscilloscope or equivalents, measure operating current of circuit.

### 1-2 Overload current

Using an oscilloscope or equivalents, measure the overload current that needs to break circuit.

#### 1–3 Inrush current

Using an oscilloscope or equivalents, measure inrush current of circuit at power-on or power-off. In addition, determine number of inrush current applied.

#### 1-4 Category temperature

Measure ambient temperature of fuse circuit.

#### EXAMPLE TO SELECT RATINGS OF TYPE JAH L Series

<Fuse selection>

Effective operating current: 2.8 A Effective overload current: 40 A Inrush current waveform: Fig. A (Pulse width: 1 ms, Wave height: 40 A)

Numbers to withstand inrush current: 100,000 times

Category temperature: 85°C

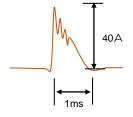


Fig. A: Inrush current waveform

## 2. Calculation from operating current

## 2-1 Measurement of operating current

Using an oscilloscope or equivalents, measure operating current (effective current) of actual circuit.

Example: Effective operating current = 2.8 A

#### 2-2 Derating

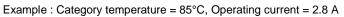
1)Temperature derating factor

Using Fig. B, find temperature derating factor correspond to temperature.

2)Rated derating factor

Rated derating factor = 0.78 (Constant irrespective of temperature)

Use Formula 1 to calculate rated current of the fuse to be used for circuit. Rated current of fuse ≥ Operating current/(①×②) ... Formula 1

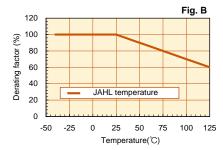


①Temperature derating factor = 0.76 (Refer to Fig. B.)

②Rated derating factor = 0.78 (Constant irrespective of temperature)

Calculation using Formula 1:

Rated current  $\geq 2.8/(0.76 \times 0.78) = 4.72 \text{ A}$ 



The above calculation result shows that the fuse with rated current of 4.72 A or more should be selected for this circuit. Type JAH L Series, with <u>rated current of 5.0 A or more</u> can be selected.

## 3. Calculation from overload current

## 3-1 Measurement of overload current

Using oscilloscope or equivalents, measure overload current that needs to break circuit.

Example: Effective overload current = 40 A

## 3-2 Calculation from overload current

Determine rated current so that overload current can be 2.0 times larger than rated current.

Use Formula 2 to calculate rated current of fuse.

Rated current of fuse ≤ Overload current/2.0 ... Formula 2

Example: Overload current = 40 A

Use Formula 2 to calculate the rated current.

Rated current  $\leq 40/2.0 = 20 \text{ A}$ 

The above calculation result shows that the fuse with rated current of 20 A or less should be selected for this circuit.

Type JAH L Series, with rated current of 12.5 A or less can be selected.

#### 4. Calculation from inrush current

## 4-1 Measurement of inrush current waveform

Using an oscilloscope or equivalent, measure waveform of inrush current of actual circuit.

## 4-2 Creation of approximate waveform

Generally, waveform of inrush current is complicated. For this reason, create the approximate waveform of inrush current as shown on Fig. C to simplify calculation.



Calculate I<sup>2</sup>t (Joule integral) of approximate waveform.

The formula for this calculation depends on the approximate waveform.

Refer to Table A.

Example: Pulse applied = 1 ms, Peak value = 40 A

Approximate waveform = Triangular wave

Since the approximate waveform is a triangular wave, use the

following formula for calculation.

 $I^{2}t$  of rush current =  $1/3 \times Im^{2} \times t$  ... Formula 3

(Im : Peak value, t : Pulse applying time)

Use Formula 3 to calculate I<sup>2</sup>t of the rush current:

 $I^2t = 1/3 \times 40 \times 40 \times 0.001 = 0.533 \text{ (A}^2\text{s)}$ 

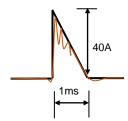


Fig. C: Inrush current waveform Red line: Actual measurement waveform Black line: Approximate waveform

## JOULE-INTEGRAL VALUES FOR EACH WAVEFORM

Table A

Name	Waveform	I²t	Name	Waveform	I²t
Sine wave (1 cycle)	$0 \frac{1}{2} \operatorname{Im}_{t}$	$\frac{1}{2}$ I m <sup>2</sup> t	Trapezoidal wave	O t <sub>1</sub> t <sub>2</sub> t <sub>3</sub> I m	$\frac{1}{3} \operatorname{Im}^{2} t_{1} + \operatorname{Im}^{2} (t_{2} - t_{1}) + \frac{1}{3} \operatorname{Im}^{2} (t_{3} - t_{2})$
Sine wave (half cycle)	0 t I m	$\frac{1}{2}$ I m <sup>2</sup> t	Various wave 1	0 t	$I_{1}I_{2}t + \frac{1}{3}(I_{1}-I_{2})^{2}t$
Triangular wave	0 t <sub>2</sub> I m	$\frac{1}{3} \operatorname{Im}^2 t$	Various wave 2	0 t <sub>1</sub> t <sub>2</sub> t <sub>3</sub> I ,	$\frac{1}{3} \frac{I_1^2 t_1 + \{I_1 I_2 + \frac{1}{3} (I_1 - I_2)^2\}}{(t_2 - t_1) + \frac{1}{3} I_2^2 (t_3 - t_2)}$
Rectangular wave	O t	I m² t	Charge/ discharge waveform	0.368 I m	-1/2 I m <sup>2</sup> τ

\* Following formula is generally used for calculation of I2t as i(t) equal to current.

$$I^2 t = \int_0^t i^2 (t) dt$$

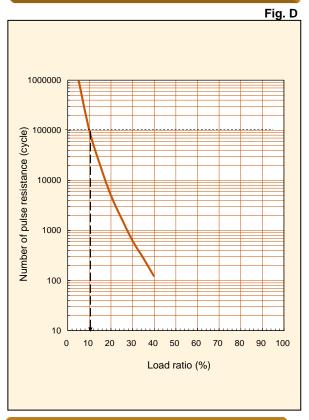
### 4-4 Search of load ratio

- ①Set up number of cycles to withstand. (generally 100,000 times)
- ②Obtain load ratio from Pulse resistance characteristics. (Fig. D)

Example: 100,000 times is required against inrush current applied.

The load ratio is 10% or less from Fig. D.

## PULSE RESISTANCE CHARACTERISTICS



## 4-5 Calculation from Joule integral and load ratio

Use Formula 4 to calculate the standard I<sup>2</sup>t for the fuse to be used.

Standard  $I^2t$  of fuse > ( $I^2t$  of inrush current/load ratio) ...........Formula 4

Example :  $I^2t$  of pulse = 0.533  $A^2s$ ,

Pulse applied = 1 ms, Required load ratio = 10%

From Formula 4,

Standard  $I^2t$  of fuse > 0.533/0.1 = 5.33 (A<sup>2</sup>s)

The standard I<sup>2</sup>t of the fuse should be 5.33 (A<sup>2</sup>s) or more.

Since the rush pulse applied is 1 ms, obtain the intersection of 1 ms (horizontal axis) and  $5.33 \, \text{A}^2$ s (vertical axis) from Fig. E (refer to the arrow shown in Fig. E).

Select a fuse whose curve is above the intersection. Type JAH L Series, with <u>rated current of 6.3 A or more</u> should be selected.

## 5. Final determination of rated value

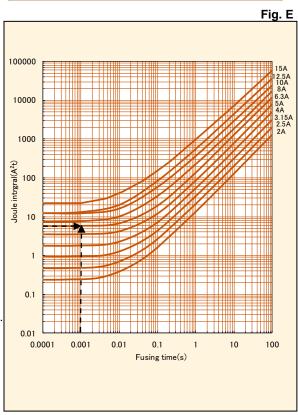
Determine the rated current of micro fuse. Rated current should meet all the calculation results.

Example : Rated current of 6.3 A~12.5A meets the all requirement.

## 6. Operation check using actual device

After selecting rating, confirm if the device works properly under pre-determined conditions.

# **JOULE INTEGRAL VS. FUSING TIME**





# Application Notes for Micro Fuse

#### 1. Circuit Design

Micro Fuse should be designated only after confirming operating conditions and Micro Fuse performance characteristics.

When determining the rated current, be sure to observe the following

- (1) Micro Fuse should always be operated below the rated current (the value considered in the temperature derating rate) and voltage specifications. According to item 2,2-2 in page 5.
- (2) Micro Fuse should always be operated below the rated voltage.
- (3) Micro Fuse should be selected with correct rated value to be fused at overload current.
- (4) When Micro Fuse are used in inrush current applications, please confirm sufficiently inrush resistance of Micro Fuse.
- (5) Please do not apply the current exceeding the breaking current to
- (6) Use Micro Fuse under the condition of category temperature.
- (7) Micro Fuse should not be used in the primary power source.

Micro Fuse should be selected by determining the operating conditions that will occur after final assembly, or estimating potential abnormalities through cycle testing.

## 2. Assembly and Mounting

During the entire assembly process, observe Micro Fuse body temperature and the heating time specified in the performance table. In addition, observe the following items:

- (1) Mounting and adjusting with soldering irons are not recommended since temperature and time control is difficult.
  - In case of emergency for using soldering irons, be sure to observe the conditions specified in the performance table.
- (2) Micro Fuse body should not contact a soldering iron directly.
- (3) Once Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
- (4) During mounting, be careful not to apply any excessive mechanical stresses to the Micro Fuse.

#### 3. Solvents

For cleaning of Micro Fuse, immersion in isopropyl alcohol for 90 seconds (at 20 ~ 30°C liquid temp.) will not be damaged. If organic solvents (Pine Alpha<sup>TM</sup>, Techno Care<sup>TM</sup>, Clean Through<sup>TM</sup>, etc.) will be applied to the Micro Fuse, be sure to preliminarily check that the solvent will not damage Micro Fuse.

## 4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for Micro Fuse. This may cause damage to Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions. If Ultrasonic cleaning process must be used, please evaluate the effects sufficiently before use.

## 5. Caution During Usage

(1) Micro Fuse with electricity should never be touched. Micro Fuse with electricity may cause burning due to Micro Fuse high temperature. Also, in case of touching Micro Fuse without electricity, please check the safety temperature of Micro Fuse.

(2) Protective eyeglasses should always be worn when performing fusing tests. However, there is a fear that Micro Fuse will explode during test. During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

#### 6. Environmental Conditions

- (1) Micro Fuse should not be operated in acid or alkali corrosive atmosphere.
- (2) Micro Fuse should not be vibrated, shocked, or pressed excessively.
- (3) Micro Fuse should not be operated in a flammable or explosive atmosphere.
- (4) Please do not use Micro fuse in the environment where dew condensation occurs.

In case Micro fuse has to be used under the dew condensation condition, please apply moisture-proof coating over Micro fuse. Covering Micro fuse with moisture-proof coating may affect electrical characteristics, please evaluate the effects sufficiently before use.

## 7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

## 8. Storage

- (1) Micro Fuse should be stored at room temperature (-10°C ~ +40°C) without direct sunlight or corrosive atmosphere such as H2S(hydrogen sulfide) or SO2(sulfur dioxide).
- Direct sunlight may cause decolorization and deformation of the exterior and taping.
- Also, solderability will be remarkably lower in high humidity.
- (2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products will be stored for longer term, please contact us for advice.
- (3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.

When Micro Fuse are disposed of as waste or "scrap", they should be treated as "industrial waste". Micro Fuse contain various kinds of metals and resins.

## 10. Samples

Micro Fuse received as samples should not be used in any products or devices in the market. Samples are provided for a particular purpose such as configuration, confirmation of electrical characteristics, etc.



# MATSUO ELECTRIC CO., LTD.

Please feel free to ask our sales department for more information on Micro Fuse.

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